

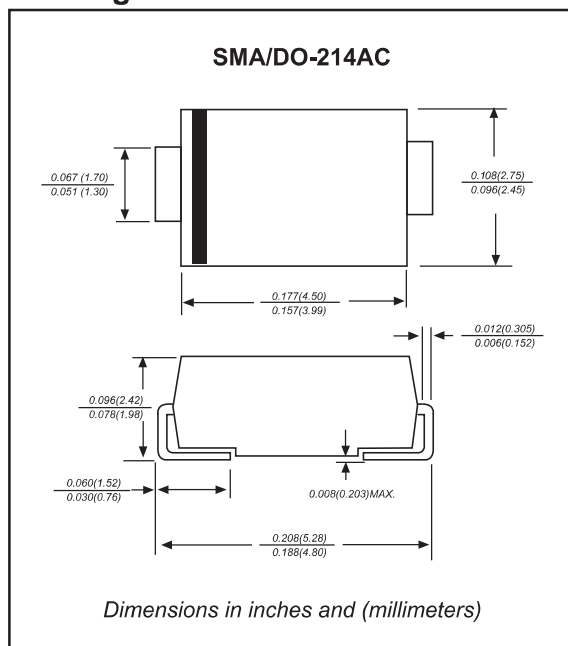
### Features

- Ideal for surface mounted application
- Low profile surface mounted application in order to optimize board space
- Built-in strain relief design
- Ultra fast recovery time for high efficient
- Glass passivated chip junction
- Lead-free parts meet RoHS requirements
- Compliant to Halogen-free

### Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, SMA(DO-214AC)
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any

### Package outline



### Maximum ratings (AT T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	600	V
Maximum RMS voltage	V <sub>RMS</sub>	420	V
Maximum continuous reverse voltage	V <sub>R</sub>	600	V
Maximum average forward rectified current	I <sub>O</sub>	1.0	A
Non-repetitive peak forward surge current 8.3ms single half sine-wave	I <sub>FSM</sub>	35	A
Typical junction capacitance (Note 1)	C <sub>J</sub>	15	pF
Operating junction temperature range	T <sub>J</sub>	-55 to +175	°C
Storage temperature range	T <sub>STG</sub>	-65 to +175	°C

### Electrical characteristics (AT T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Maximum instantaneous forward voltage at I <sub>F</sub> =1.0A T <sub>J</sub> =25°C	V <sub>F</sub>	1.25	V
Maximum instantaneous forward voltage at I <sub>F</sub> =1.0A T <sub>J</sub> =150°C	V <sub>F</sub>	1.05	V
Maximum reverse leakage current at rated V <sub>R</sub>	I <sub>R</sub>	5.0 150	μA
Maximum reverse recovery time, (Note 2)	t <sub>rr</sub>	50	ns

### Thermal characteristics

PARAMETER	SYMBOLS	MURA160T3G	UNITS
Typical thermal resistance junction to ambient , (Note 3)	R <sub>θJA</sub>	25	°C / W
Typical thermal resistance junction to case , (Note 3)	R <sub>θJC</sub>	15	°C / W

Notes 1: Measured at 1 MHz and applied reverse voltage of 4.0 VDC  
 2: Measured with I<sub>F</sub> = 0.5 A, I<sub>R</sub> = 1 A, I<sub>rr</sub> = 0.25 A  
 3: Mounted on FR-4 PCB Copper, minimum recommended pad layout

## Rating and characteristic curves

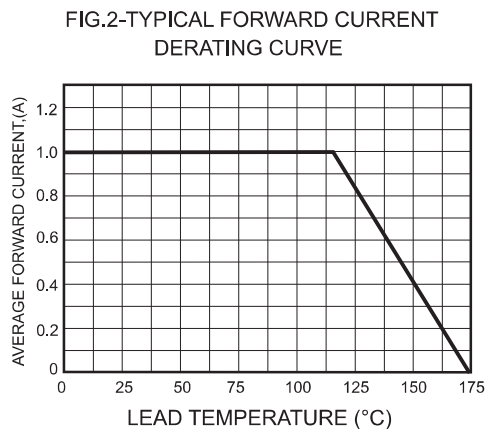
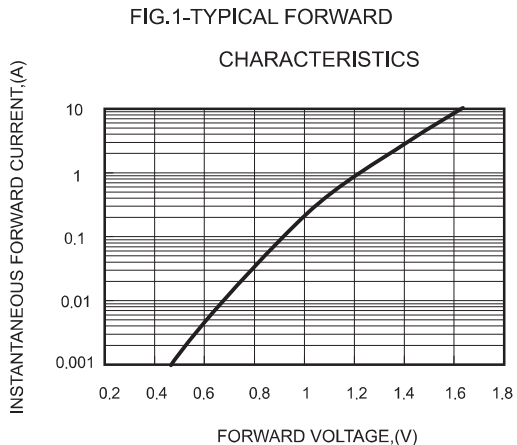
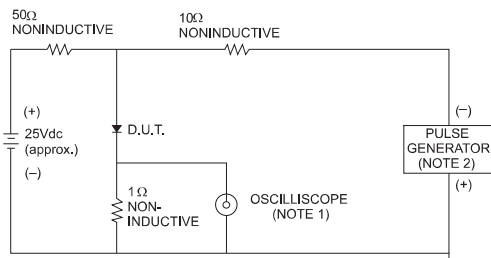


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.  
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

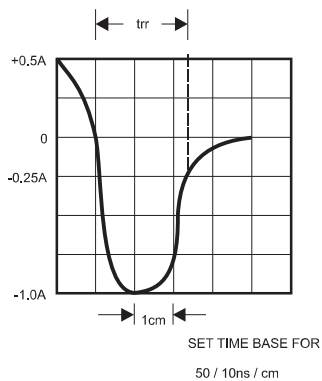


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

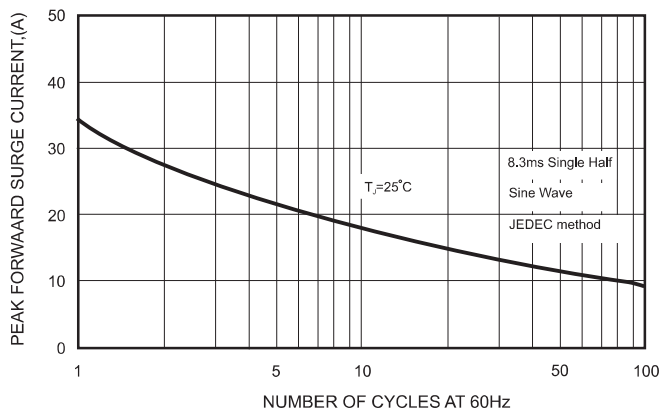
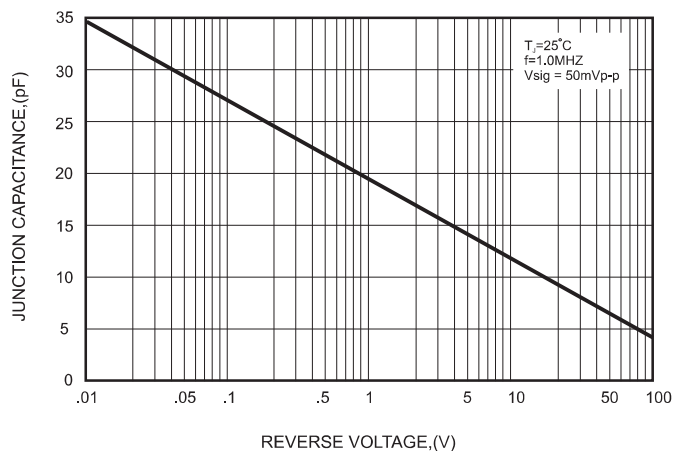




FIG.5-TYPICAL JUNCTION CAPACITANCE



**Pinning information**

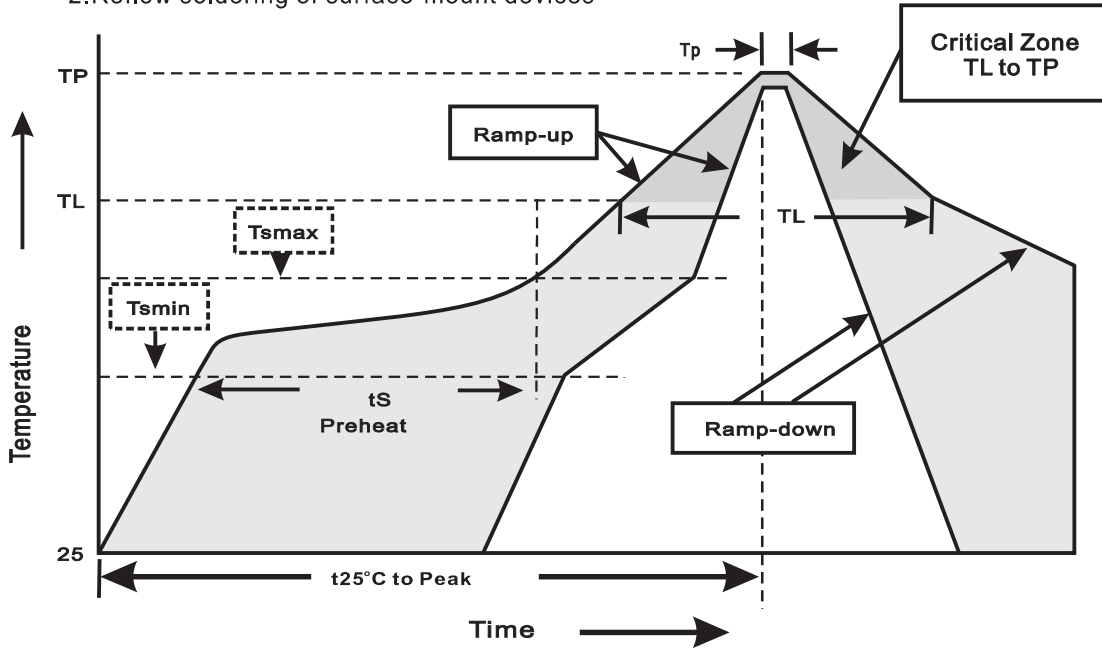
Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

**Marking**

Type number	Marking code
MURA160T3G	HL6

**Suggested thermal profiles for soldering processes**

- 1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%
- 2.Reflow soldering of surface-mount devices



3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(T <sub>L</sub> to T <sub>P</sub> )	<3°C/sec
Preheat -Temperature Min(T <sub>smmin</sub> ) -Temperature Max(T <sub>smmax</sub> ) -Time(min to max)(t <sub>s</sub> )	150°C 200°C 60~120sec
T <sub>smmax</sub> to T <sub>L</sub> -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(T <sub>L</sub> ) -Time(t <sub>L</sub> )	217°C 60~260sec
Peak Temperature(T <sub>P</sub> )	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t <sub>P</sub> )	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes

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